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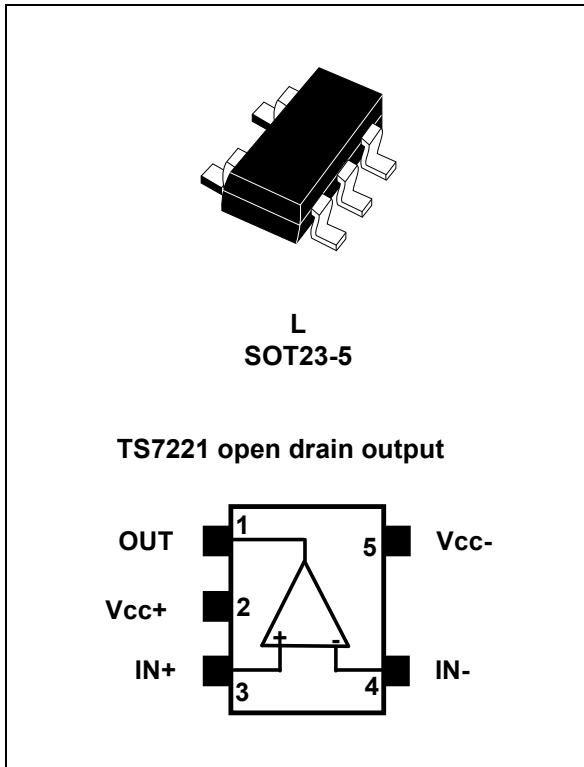
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Single BiCMOS rail-to-rail micropower comparator

Datasheet - production data

**Applications**

- Battery-powered systems
- Notebooks and PDAs
- PCMCIA cards
- Cellular and mobile communications
- Alarms and security systems
- To replace amplifiers used in comparator configurations for improved performance

Description

The TS7221 is a micropower comparator featuring a rail-to-rail input performance in a tiny SOT23-5 package. This comparator is ideally suited to space and weight-critical applications. It is fully specified at 2.7 V, 5 V and 10 V operation.

The TS7221 features an open-drain output stage. The speed-to-power ratio makes this device ultra-versatile for a wide range of applications.

Features

- Rail-to-rail inputs
- Open drain output
- Supply operation from 2.7 to 10 V
- Typical supply current: 6 μ A at 5 V
- Response time of 0.5 μ s at 5 V
- Low input current
- ESD protection: 2 kV (HBM), 200 V (MM)
- Available in tiny SOT23-5 package

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1 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	12	V
V_{ID}	Differential input voltage	$(V_{CC}^-) - 0.3$ to $(V_{CC}^+) + 0.3$	
V_{IN}	Input voltage ⁽¹⁾		
V_{OUT}	Output voltage	12	
I_{IN}	Current at input pins ⁽¹⁾	± 5	mA
I_{OUT}	Current at output pin	± 30	
R_{thja}	Thermal resistance junction to ambient ⁽²⁾ SOT23-5	250	°C/W
R_{thjc}	Thermal resistance junction to case ⁽²⁾ SOT23-5	81	
T_{Lead}	Lead temperature (soldering 10 seconds)	260	°C
T_{stg}	Storage temperature	-65 to +150	
T_J	Junction temperature	150	
ESD	Human body model (HBM) ⁽³⁾	2000	V
	Machine model (MM) ⁽⁴⁾	200	

1. The magnitude of input voltages must never exceed 0.3 V beyond the supply voltage.
2. Short-circuits can cause excessive heating. This value is typical.
3. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 k Ω resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
4. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.7 to 10	V
T_{amb}	Ambient temperature TS7221A1LT and TS7221B1LT TS7221A11LT	-40 to +85 -40 to +105	°C
V_{icm}	Common mode input voltage range	$(V_{CC}^-) - 0.3$ to $(V_{CC}^+) + 0.3$	V

2 Electrical characteristics

Table 3. Electrical characteristics at $V_{CC}^+ = 2.7\text{ V}$, $T_{amb} = 25\text{ °C}$ (unless otherwise specified)⁽¹⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IO}	Input offset voltage (full common mode range)				mV
	– TS7221A at $T_{min} \leq T_{amb} \leq T_{max}$			7 10	
	– TS7221B at $T_{min} \leq T_{amb} \leq T_{max}$			15 18	
ΔV_{IO}	Input offset voltage drift with temperature		6		$\mu\text{V}/\text{°C}$
I_{IB}	Input bias current ⁽²⁾ at $T_{min} \leq T_{amb} \leq T_{max}$		1	300 600	pA
I_{IO}	Input offset current ⁽²⁾ at $T_{min} \leq T_{amb} \leq T_{max}$		1	150 300	
CMRR	Common-mode rejection ratio ($0 < V_{icm} < 2.7\text{ V}$)		65		dB
PSRR	Power supply rejection ratio ($2.7 < V_{CC} < 10\text{ V}$)		80		
A_{VD}	Voltage gain ⁽³⁾		240		
V_{icm}	Input common mode voltage range at $T_{min} \leq T_{amb} \leq T_{max}$	-0.3 0.0		3 2.7	V
I_{OH}	High level output voltage ($I_{N^+} = 0.5\text{ V}$, $I_{N^-} = 0\text{ V}$ and $OUT = 10\text{ V}$)		0.1	500	nA
V_{OL}	Low level output voltage, $I_{sink} = 5\text{ mA}$ at $T_{min} \leq T_{amb} \leq T_{max}$		0.2	0.35 0.45	V
I_{CC}	Supply current				μA
	– Output low – Output high		6 8	12 14	
T_{PLH}	Response time low to high ($V_{ic} = 1.35\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$)				
	– Overdrive = 10 mV – Overdrive = 100 mV		1.5 0.6		
T_{PHL}	Response time high to low ($V_{ic} = 1.35\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$)				μs
	– Overdrive = 10 mV – Overdrive = 100 mV		1.5 0.5		
T_F	Fall time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		
T_R	Rise time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		

- Limits are 100 % production-tested at +25 °C. Behavior at temperature range limits is guaranteed through correlation and by design.
- Maximum values include unavoidable inaccuracies of industrial testing.
- Design evaluation.

Table 4. Electrical characteristics for $V_{CC}^+ = 5\text{ V}$, $T_{\text{amb}} = 25\text{ °C}$ (unless otherwise specified)⁽¹⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IO}	Input offset voltage (full common mode range) – TS7221A at $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$ – TS7221B $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$			7 10 15 18	mV
ΔV_{IO}	Input offset voltage drift with temperature		6		$\mu\text{V}/^\circ\text{C}$
I_{IB}	Input bias current ⁽²⁾ at $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$		1	300 600	pA
I_{IO}	Input offset current ⁽²⁾ at $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$		1	150 300	
CMRR	Common-mode rejection ratio ($0 < V_{\text{icm}} < 5\text{ V}$)		70		dB
PSRR	Power supply rejection ratio ($2.7 < V_{CC} < 10\text{ V}$)		80		
A_{VD}	Voltage gain ⁽³⁾		240		
V_{icm}	Input common mode voltage range at $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$	-0.3 0.0		5.3 5.0	V
I_{OH}	High level output voltage ($I_{N^+} = 0.5\text{ V}$, $I_{N^-} = 0\text{ V}$ and $\text{OUT} = 10\text{ V}$)		0.1	500	nA
V_{OL}	Low level output voltage, $I_{\text{sink}} = 5\text{ mA}$ at $T_{\text{min}} \leq T_{\text{amb}} \leq T_{\text{max}}$		0.2	0.40 0.55	V
I_{CC}	Supply current – Output low – Output high		6 8	12 14	μA
T_{PLH}	Response time low to high ($V_{\text{ic}} = 2.5\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$) – Overdrive = 10 mV – Overdrive = 100 mV		2 0.5		μs
T_{PHL}	Response time high to low ($V_{\text{ic}} = 2.5\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$) – Overdrive = 10 mV – Overdrive = 100 mV		2 0.4		
T_F	Fall time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		
T_R	Rise time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		

1. Limits are 100% production-tested at +25 °C. Behavior at temperature range limits is guaranteed through correlation and by design.
2. Maximum values include unavoidable inaccuracies of industrial testing.
3. Design evaluation.

Table 5. Electrical characteristics for $V_{CC}^+ = 10\text{ V}$, $T_{amb} = 25\text{ °C}$ (unless otherwise specified)⁽¹⁾

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IO}	Input offset voltage (full common mode range) – TS7221A at $T_{min} \leq T_{amb} \leq T_{max}$ – TS7221B $T_{min} \leq T_{amb} \leq T_{max}$			7 10 15 18	mV
ΔV_{IO}	Input offset voltage drift with temperature		6		$\mu\text{V}/\text{°C}$
I_{IB}	Input bias current ⁽²⁾ at $T_{min} \leq T_{amb} \leq T_{max}$		1	300 600	pA
I_{IO}	Input offset current ⁽²⁾ at $T_{min} \leq T_{amb} \leq T_{max}$		1	150 300	
CMRR	Common-mode rejection ratio ($0 < V_{icm} < 10\text{ V}$)		75		dB
PSRR	Power supply rejection ratio ($2.7 < V_{CC} < 10\text{ V}$)		80		
A_{VD}	Voltage gain ⁽³⁾		240		
V_{ICM}	Input common mode voltage range at $T_{min} \leq T_{amb} \leq T_{max}$	-0.3 0.0		10.3 10.0	V
I_{OH}	High level output voltage ($I_N^+ = 0.5\text{ V}$, $I_N^- = 0\text{ V}$ and $O_{UT} = 10\text{ V}$)		0.1	500	nA
V_{OL}	Low level output voltage, $I_{sink} = 5\text{ mA}$ at $T_{min} \leq T_{amb} \leq T_{max}$		0.2	0.40 0.55	V
I_{CC}	Supply current – Output low – Output high		7 10	14 16	μA
T_{PLH}	Response time low to high ($V_{ic} = 5\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$) – Overdrive = 10 mV – Overdrive = 100 mV		3 0.5		μs
T_{PHL}	Response time high to low ($V_{ic} = 5\text{ V}$, $C_L = 50\text{ pF}$, $R_L = 10\text{ k}\Omega$) – Overdrive = 10 mV – Overdrive = 100 mV		4 0.4		
T_F	Fall time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		
T_R	Rise time $C_L = 50\text{ pF}$, $R_L = 5\text{ k}\Omega$, overdrive = 10 mV		0.3		

1. Limits are 100% production-tested at +25 °C. Behavior at temperature range limits is guaranteed through correlation and by design.
2. Maximum values include unavoidable inaccuracies of industrial testing.
3. Design evaluation.

Figure 1. Supply current vs. supply voltage (output low)

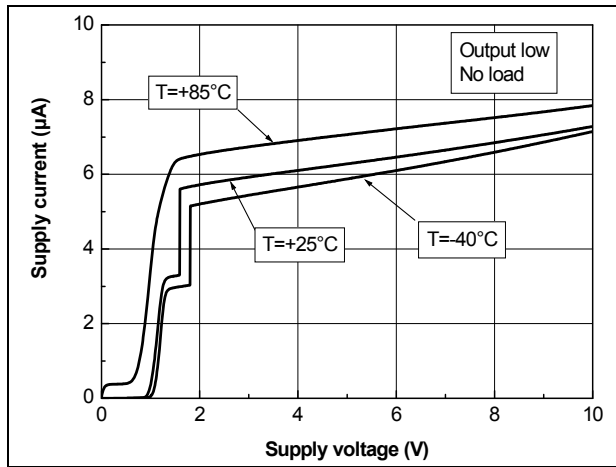


Figure 2. Supply current vs. supply voltage (output high)

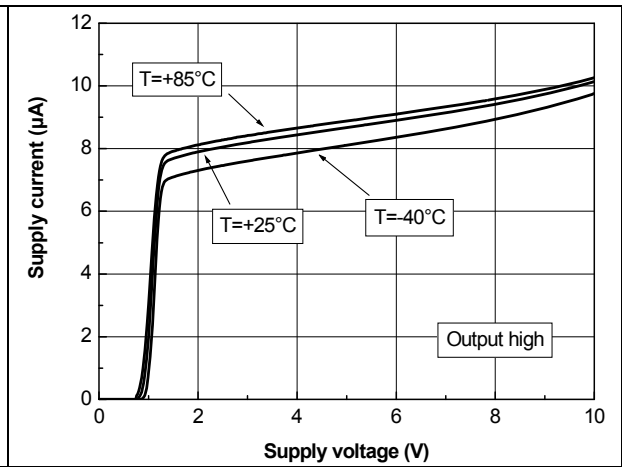


Figure 3. Output sinking current vs. output voltage at $V_{CC} = +2.7\text{ V}$, $V_{CC} = +5\text{ V}$

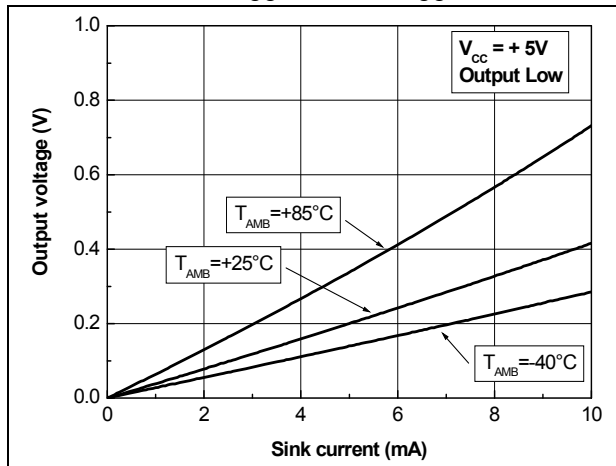


Figure 4. V_{IO} vs. V_{ICM} and temperature at $V_{CC} = 2.7\text{ V}$

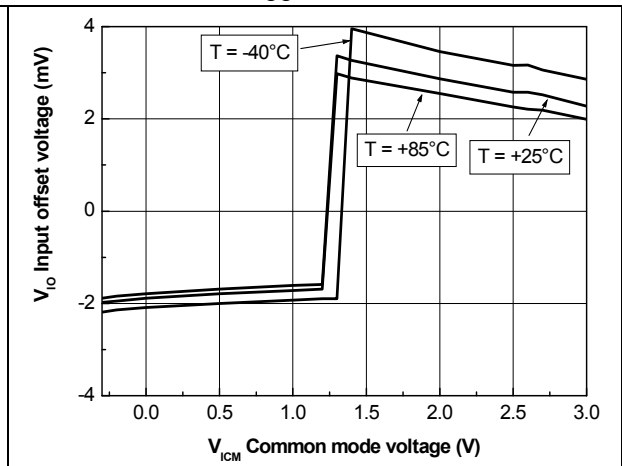


Figure 5. V_{IO} vs. V_{ICM} and temperature at $V_{CC} = 5\text{ V}$

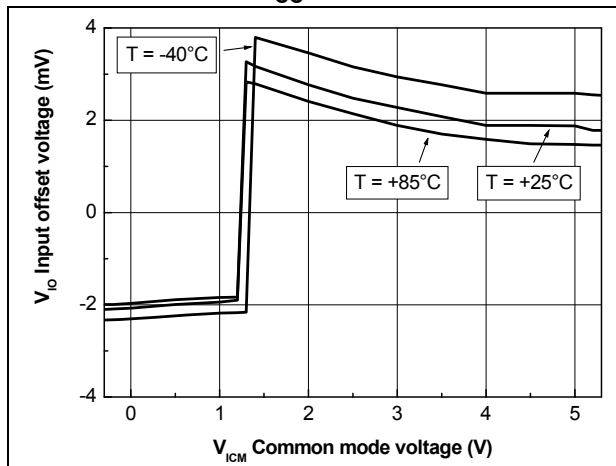


Figure 6. V_{IO} vs. V_{ICM} and temperature at $V_{CC} = 10\text{ V}$

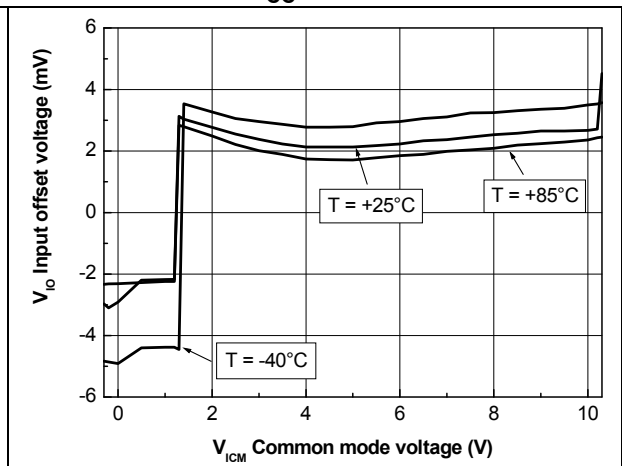


Figure 7. T_{PLH} vs V_{icm} at $V_{CC} = 10\text{ V}$ and 10 mV overdrive

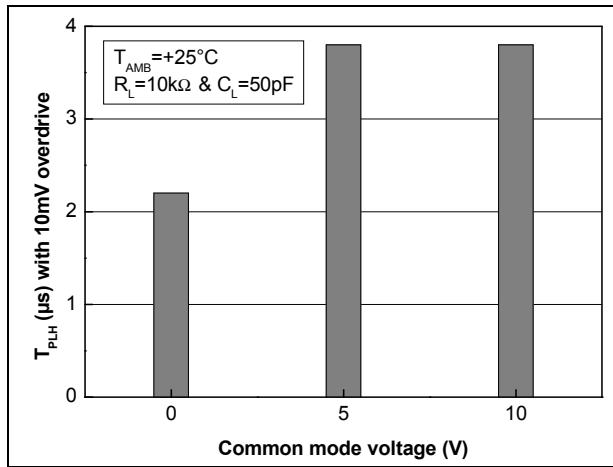


Figure 8. T_{PLH} vs V_{icm} at $V_{CC} = 10\text{ V}$ and 100 mV overdrive

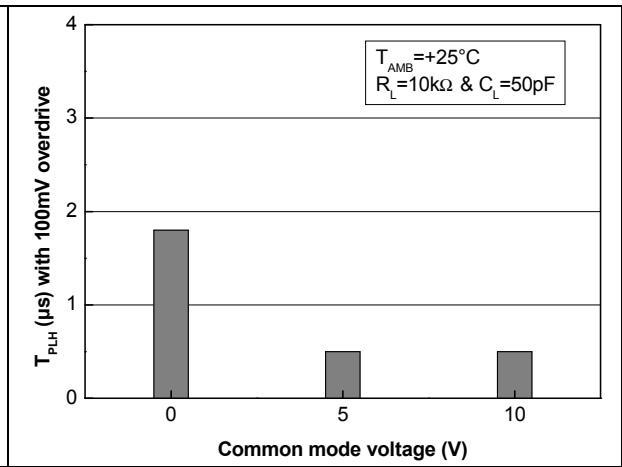


Figure 9. T_{PLH} vs V_{icm} at $V_{CC} = 5\text{ V}$ and 10 mV overdrive

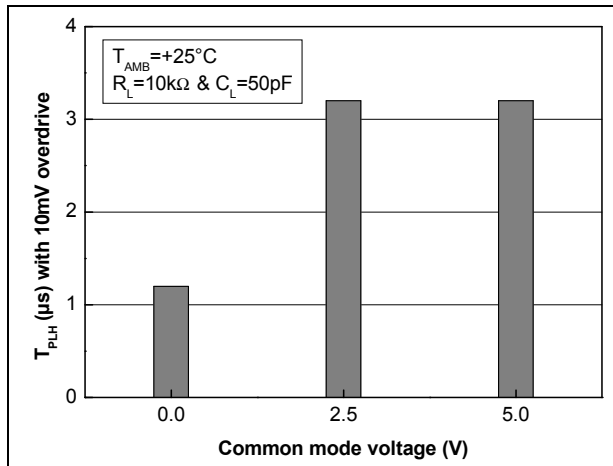


Figure 10. T_{PLH} vs V_{icm} at $V_{CC} = 5\text{ V}$ and 100 mV overdrive

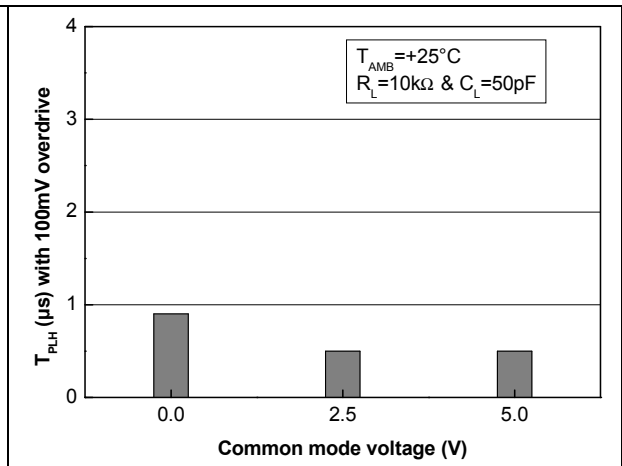


Figure 11. T_{PHL} vs V_{icm} at $V_{CC} = 10\text{ V}$ and 10 mV overdrive

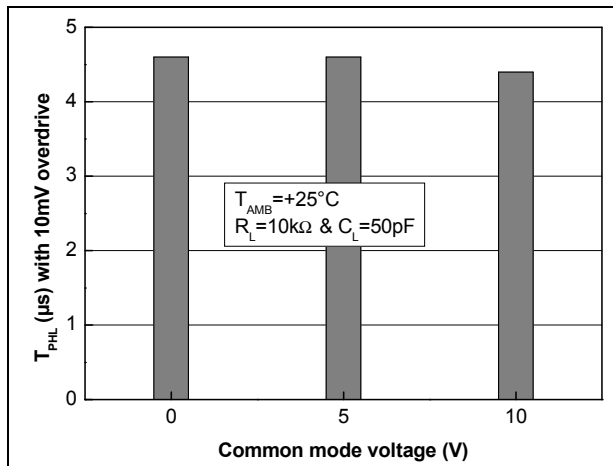


Figure 12. T_{PHL} vs V_{icm} at $V_{CC} = 10\text{ V}$ and 100 mV overdrive

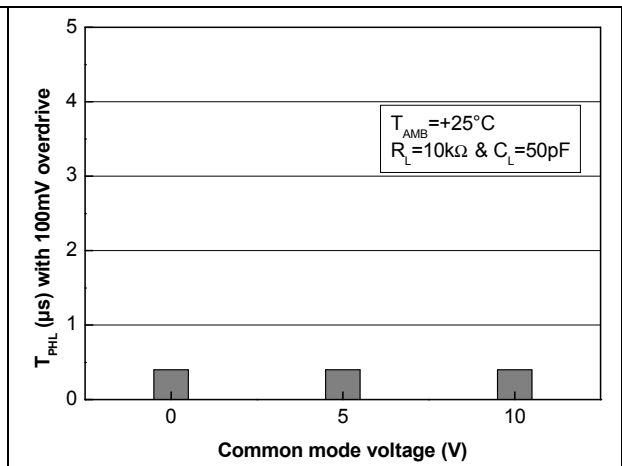
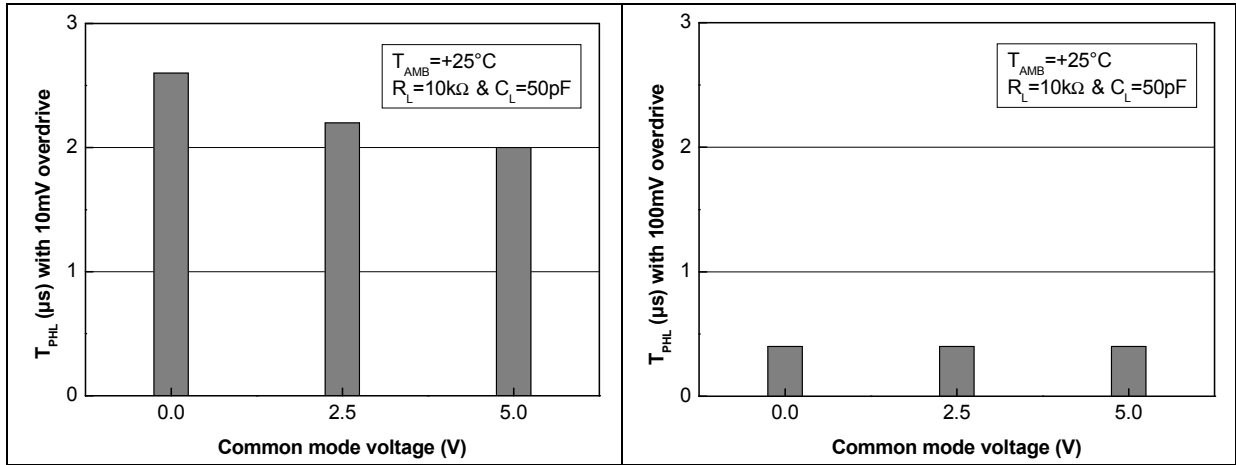


Figure 13. T_{PHL} vs V_{icm} at $V_{CC} = 5\text{ V}$ and 10 mV overdrive
 Figure 14. T_{PHL} vs V_{icm} at $V_{CC} = 5\text{ V}$ and 100 mV overdrive



3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

3.1 SOT23-5 package information

Figure 15. SOT23-5 package mechanical drawing

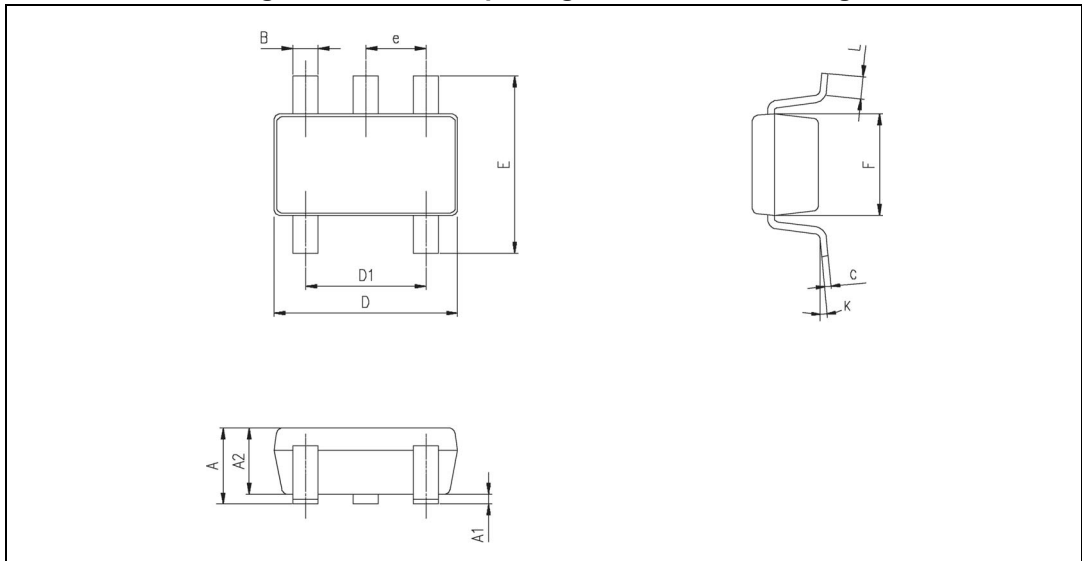


Table 6. SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90	1.20	1.45	0.035	0.047	0.057
A1			0.15			0.006
A2	0.90	1.05	1.30	0.035	0.041	0.051
B	0.35	0.40	0.50	0.013	0.015	0.019
C	0.09	0.15	0.20	0.003	0.006	0.008
D	2.80	2.90	3.00	0.110	0.114	0.118
D1		1.90			0.075	
e		0.95			0.037	
E	2.60	2.80	3.00	0.102	0.110	0.118
F	1.50	1.60	1.75	0.059	0.063	0.069
L	0.10	0.35	0.60	0.004	0.013	0.023
K	0 degrees		10 degrees	0 degrees		10 degrees

4 Ordering information

Table 7. Order codes

Order code	Temperature range	Package	Packing	Marking
TS7221A1LT	-40 °C, 85 °C	SOT23-5	Tape and reel	K518
TS7221B1LT				K519
TS7221A11LT	-40 °C, 105 °C			K525

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
01-Dec-2002	1	Initial release
01-Sep-2005	2	Update of datasheet presentation and format. Change of T_{lead} temperature in Table 1 on page 3 , to reflect change to Pb-free package. Corrections to V_{icm} upper rail parameters in Electrical characteristics tables. Addition of Pb-free information in Section 3: Package information on page 10 . Correction to package mechanical data given in Figure 15 on page 11 .
26-Mar-2007	3	Added automotive grade part numbers in Section 4: Ordering information on page 12 .
05-Jul-2007	4	Corrected automotive grade part numbers in Table 7: Order codes .
27-Mar-2009	5	Added notes for ESD in Table 1: Absolute maximum ratings . Added R_{thja} and R_{thjc} parameters in Table 1: Absolute maximum ratings . Removed power dissipation parameter (P_D) in Table 1: Absolute maximum ratings . Updated package information in Section 3.1 . Removed automotive grade part numbers in Table 7: Order codes .
01-Apr-2014	6	Description : removed industrial temperature range Table 2: Operating conditions : updated values for T_{amb} Table 7: Order codes ; added order code TS7221A11LT Removed "L" from SOT23-5 package name

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